





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

+48/23/2ler Attorney Docket No.: 040679/043

In re patent application of

Haruhiko MURATA et al.

Serial No.: 08/825,400

Filed: March 28, 1997

Group Art Unit: 2827

Examiner: K. Cuneo

For: IMPROVEMENT IN OR RELATING TO CIRCUIT BOARD HAVING SOLDER

BUMPS

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated July 16, 2002, Applicants hereby elect claims of Group I, claims 13-15, 17-23 and 29-30, for prosecution in the subject application.

Upon allowance of the elected claims, Applicants will be permitted to request rejoinder in accordance with MPEP 821.04 and In re Ochiai, 71 F.3d 1565 USPO2d 1127 (Fed.Cir. 1995) of method claims 24-28 and 31-33.

Receipt of the initial Office Action on the merits is awaited.

Respectfully submitted,

Date:

Richard L. Schwaab Registration No. 25,479

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